

**Please note that Cypress is an Infineon Technologies Company.**

The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

**Continuity of document content**

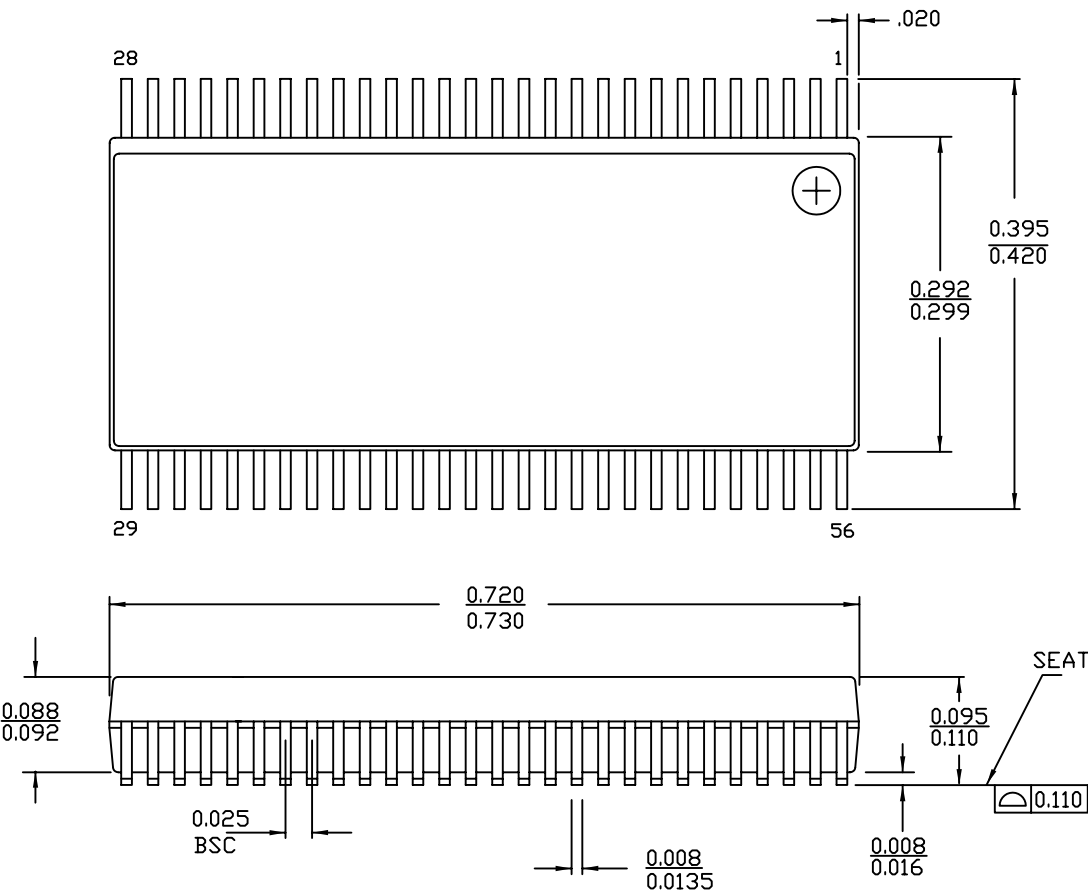
The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

**Continuity of ordering part numbers**

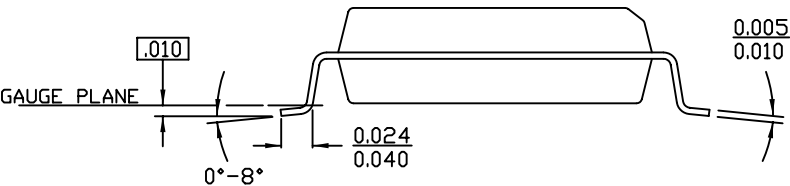
Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.


REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	-	**	1044	NEW RELEASE	11/11/94	N/A
1	-	*A	44328	CHG. LEAD SPREAD PKG. WIDTH FROM 0.400/0.410 TO 0.395/0.420	08/05/96	N/A
1	-	*B	49410	CHANGE TITLE	06/11/97	N/A
1	-	*C	100361	ADD LEAD THICKNESS DIM.	04/28/00	N/A
1	-	*D	2851411	Changed template, & title from 56LD (300 MIL) SSOP PKG OUTLINE to PACKAGE OUTLINE, 56LD SSOP 300 MILS 0563.	01/15/10	QAD
1	-	*E	3353048	Update spec for Sunset Review, no change.	08/24/11	QAD
1	-	*F	3726162	Added package weight reference info.	08/28/12	QAD

56 Lead Shrunk Small Outline Package 056



- NOTE:
1. PACKAGE WEIGHT : REFER TO PMDD SPEC.
  2. DIMENSIONS IN INCHES MIN.  
MAX.



UNLESS OTHERWISE SPECIFIED ALL DIMENSIONS ARE IN MILLIMETERS STANDARD TOLERANCES ARE: DECIMALS .XX ± 0.05 .XXX ± .XXXX + ANGLES ± 1°	DESIGNED BY	DATE	 <b>CYPRESS</b> Company Confidential		
	HTN	04/28/00			
	DRAWN BY	DATE			
	HTN	04/28/00			
MATERIAL N/A FINISH N/A	CHECKED BY	DATE	TITLE PACKAGE OUTLINE, 56LD SSOP 300 MILS 0563		
	XANC	08/28/12			
	APPROVED BY	DATE			
	QAD	08/28/12			
	APPROVED BY	DATE	SIZE	PART NO.	DWG NO
	EDCA	08/28/12	A	0563	51-85062
	APPROVED BY	DATE	REV		
	N/A	N/A	*F		
			SCALED TO FIT	N/A	SHEET 1 OF 1

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